

# **DATA SHEET**

## **BF547W** **NPN 1 GHz wideband transistor**

Product specification

June 1994

Supersedes data of November 1992

File under Discrete Semiconductors, SC14

**Philips Semiconductors**



**PHILIPS**

**NPN 1 GHz wideband transistor****BF547W****FEATURES**

- Stable oscillator operation
- High current gain
- Good thermal stability.

**DESCRIPTION**

Silicon NPN transistor in a plastic SOT323 (S-mini) package. The BF547W uses the same crystal as the SOT23 version, BF547.

**APPLICATIONS**

It is primarily intended as a mixer, oscillator and IF amplifier in UHF and VHF tuners.

**PINNING**

PIN	DESCRIPTION
1	base
2	emitter
3	collector

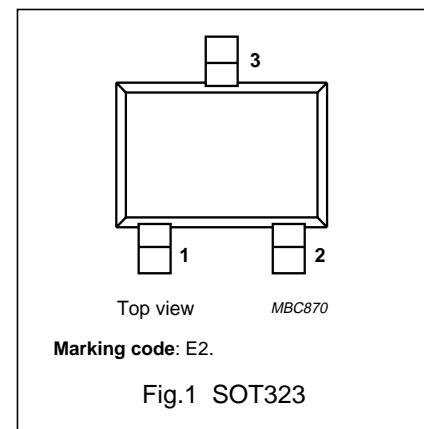


Fig.1 SOT323

**QUICK REFERENCE DATA**

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{CBO}$	collector-base voltage	open emitter	–	–	30	V
$V_{CEO}$	collector-emitter voltage	open base	–	–	20	V
$I_C$	collector current (DC)		–	–	50	mA
$P_{tot}$	total power dissipation	up to $T_s = 63^\circ\text{C}$ ; note 1	–	–	300	mW
$h_{FE}$	DC current gain	$I_C = 2 \text{ mA}; V_{CE} = 10 \text{ V}$	40	95	250	
$C_{re}$	feedback capacitance	$I_C = 0; V_{CB} = 10 \text{ V}; f = 1 \text{ MHz}$	–	1	–	pF
$f_T$	transition frequency	$I_C = 15 \text{ mA}; V_{CE} = 10 \text{ V}; f = 500 \text{ MHz}$	0.8	1.2	1.6	GHz
$G_{UM}$	maximum unilateral power gain	$I_C = 1 \text{ mA}; V_{CE} = 10 \text{ V}; f = 100 \text{ MHz}; T_{amb} = 25^\circ\text{C}$	–	20	–	dB

**LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{CBO}$	collector-base voltage	open emitter	–	30	V
$V_{CEO}$	collector-emitter voltage	open base	–	20	V
$V_{EBO}$	emitter-base voltage	open collector	–	3	V
$I_C$	collector current (DC)		–	50	mA
$P_{tot}$	total power dissipation	up to $T_s = 63^\circ\text{C}$ ; note 1	–	300	mW
$T_{stg}$	storage temperature		–65	+150	°C
$T_j$	junction temperature		–	+150	°C

**Note to the “Quick reference data” and “Limiting values”**

1.  $T_s$  is the temperature at the soldering point of the collector pin.

## NPN 1 GHz wideband transistor

BF547W

**THERMAL CHARACTERISTICS**

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th\ j-s}$	thermal resistance from junction to soldering point	up to $T_s = 63^\circ\text{C}$ ; note 1	290	K/W

**Note**

1.  $T_s$  is the temperature at the soldering point of the collector pin.

**CHARACTERISTICS**

$T_j = 25^\circ\text{C}$  (unless otherwise specified).

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(BR)CBO}$	collector-base breakdown voltage	$I_C = 0.01 \text{ mA}; I_E = 0$	—	—	30	V
$V_{(BR)CEO}$	collector-emitter breakdown voltage	$I_C = 10 \text{ mA}; I_B = 0$	—	—	20	V
$V_{(BR)EBO}$	emitter-base breakdown voltage	$I_E = 0.01 \text{ mA}; I_C = 0$	—	—	3	V
$I_{CBO}$	collector cut-off current	$I_E = 0; V_{CB} = 10 \text{ V}$	—	—	100	nA
$h_{FE}$	DC current gain	$I_C = 2 \text{ mA}; V_{CE} = 10 \text{ V}$	40	95	250	
$C_{re}$	feedback capacitance	$I_C = 0; V_{CB} = 10 \text{ V}; f = 1 \text{ MHz}$	—	1	—	pF
$f_T$	transition frequency	$I_C = 15 \text{ mA}; V_{CE} = 10 \text{ V}; f = 500 \text{ MHz}$	0.8	1.2	1.6	GHz
$G_{UM}$	maximum unilateral power gain; note 1	$I_C = 1 \text{ mA}; V_{CE} = 10 \text{ V}; f = 100 \text{ MHz}; T_{amb} = 25^\circ\text{C}$	—	20	—	dB

**Note**

1.  $G_{UM}$  is the maximum unilateral power gain, assuming  $s_{12}$  is zero.  $G_{UM} = 10 \log \frac{|s_{21}|^2}{(1 - |s_{11}|^2)(1 - |s_{22}|^2)} \text{ dB}$ .

## NPN 1 GHz wideband transistor

BF547W

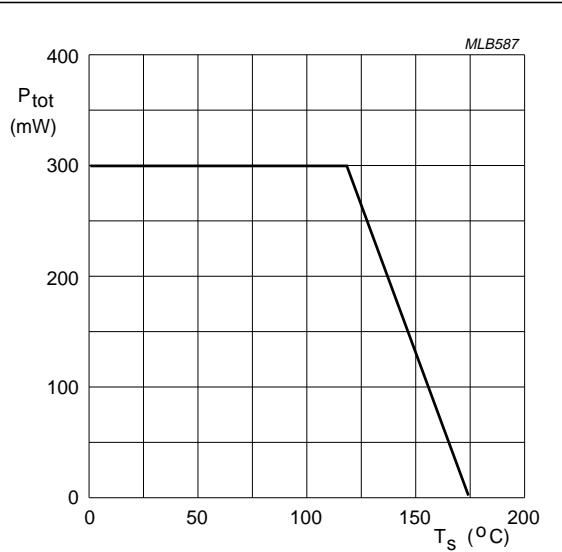


Fig.2 Power derating curve.

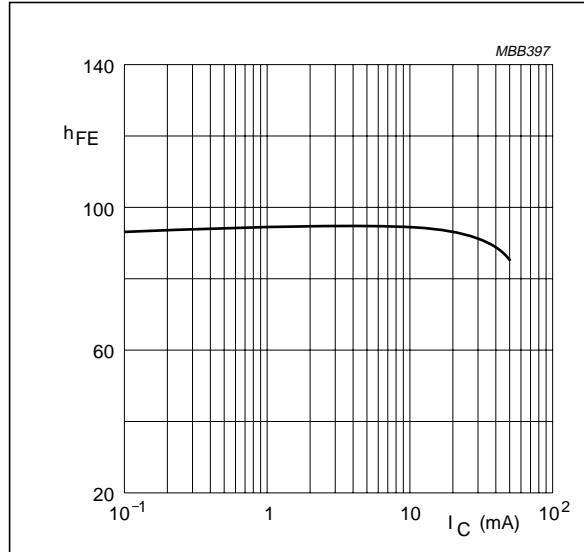
 $V_{CE} = 10$  V;  $T_j = 25$  °C.

Fig.3 DC current gain as a function of collector current; typical values.

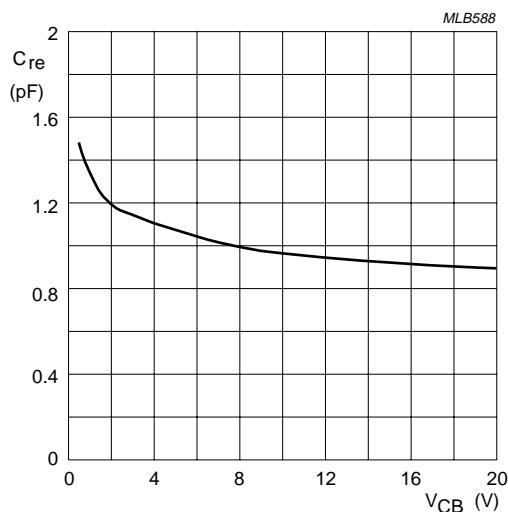
 $I_C = 0$ ;  $f = 1$  MHz.

Fig.4 Feedback capacitance as a function of collector-base voltage; typical values.

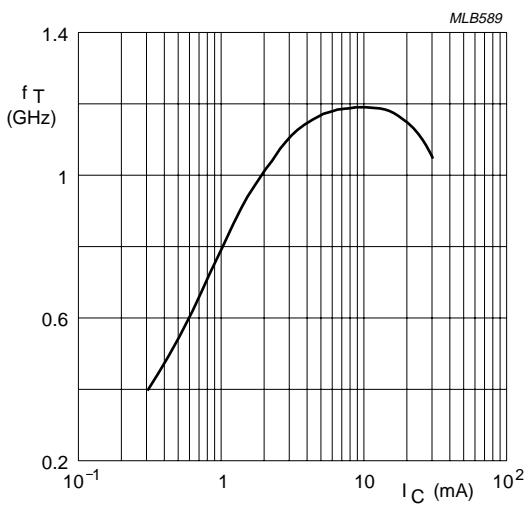
 $V_{CE} = 10$  V;  $f = 500$  MHz.

Fig.5 Transition frequency as a function of collector current; typical values.

## NPN 1 GHz wideband transistor

BF547W

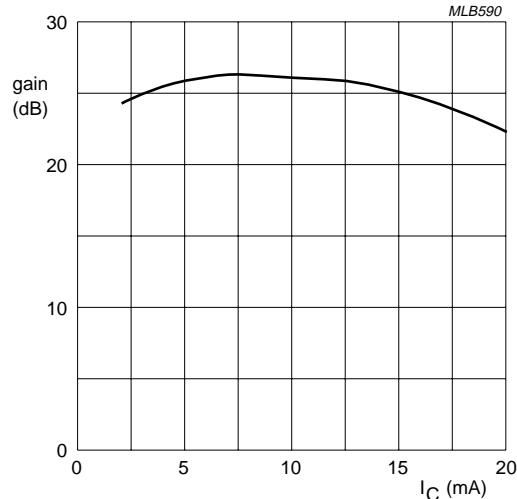
 $V_{CE} = 10$  V;  $f = 100$  MHz.

Fig.6 Gain as a function of collector current; typical values.

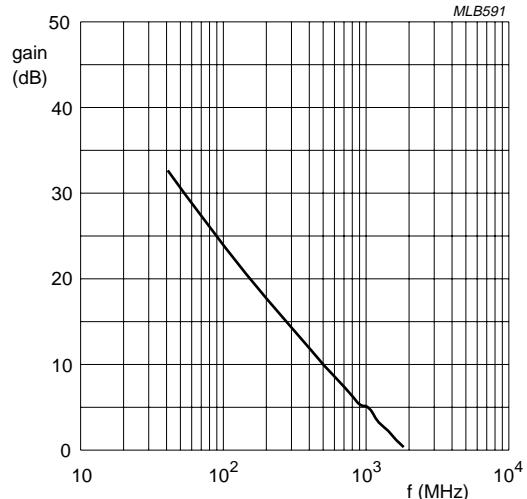
 $V_{CE} = 10$  V;  $I_C = 15$  mA.

Fig.7 Gain as a function of frequency; typical values.

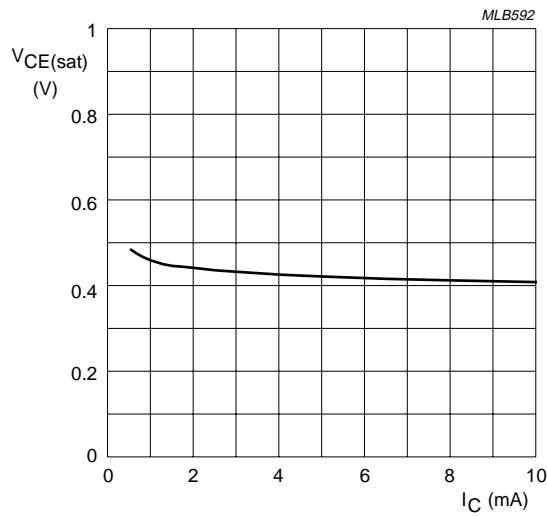
 $I_C/I_B = 10$ .

Fig.8 Collector-emitter saturation voltage as a function of collector current; typical values.

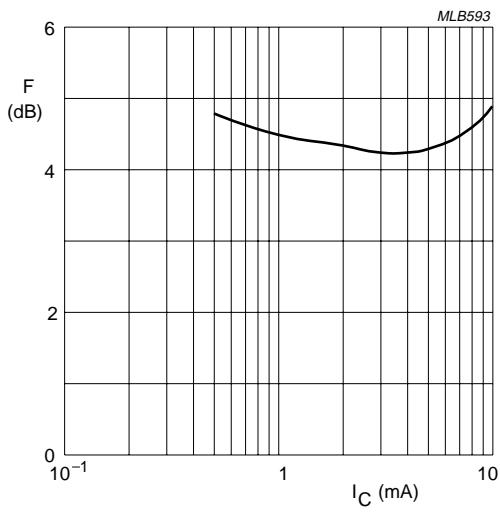
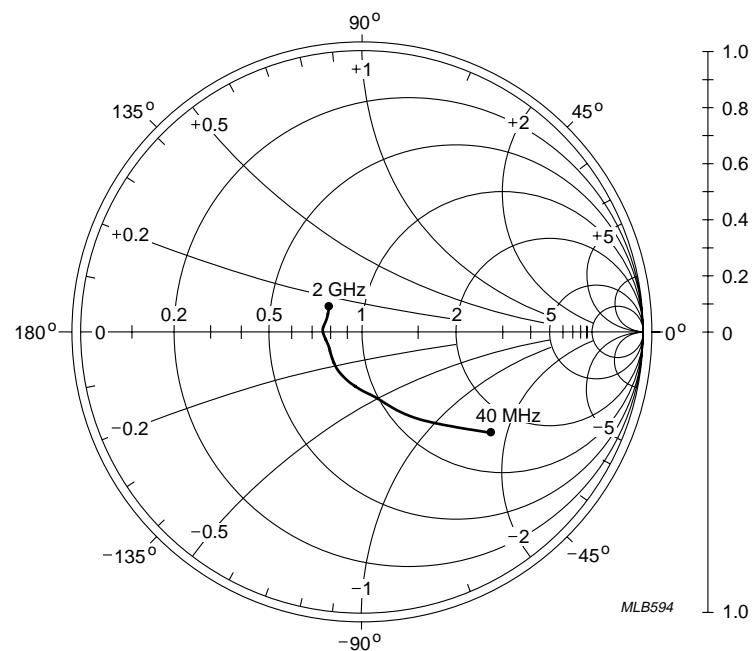
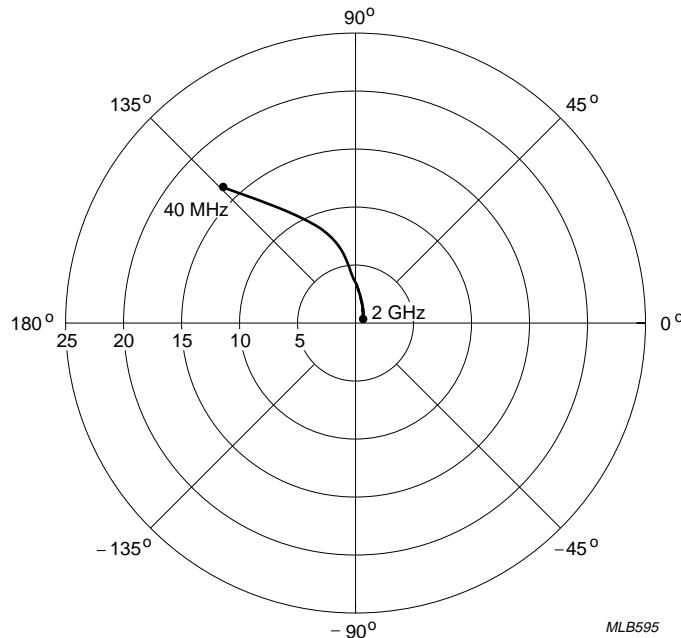
 $V_{CE} = 10$  V;  $Z_S = Z_L = 50 \Omega$ ;  $f = 100$  MHz.

Fig.9 Minimum noise figure as a function of collector current; typical values.

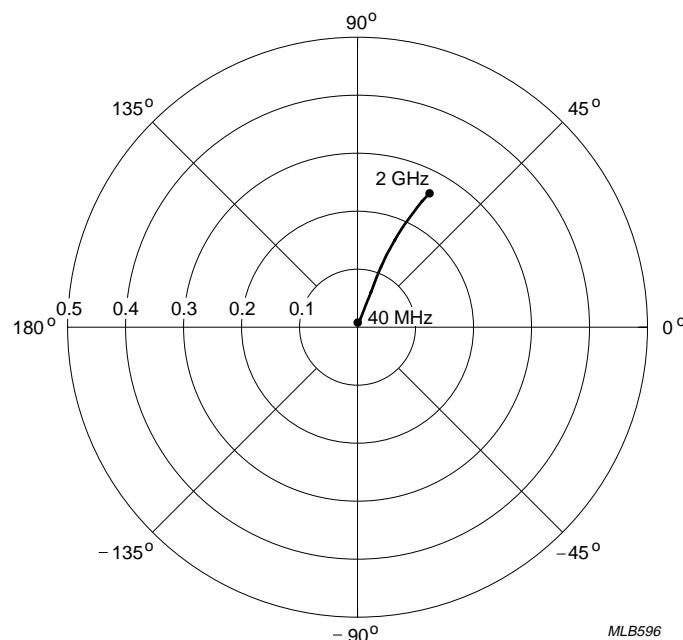
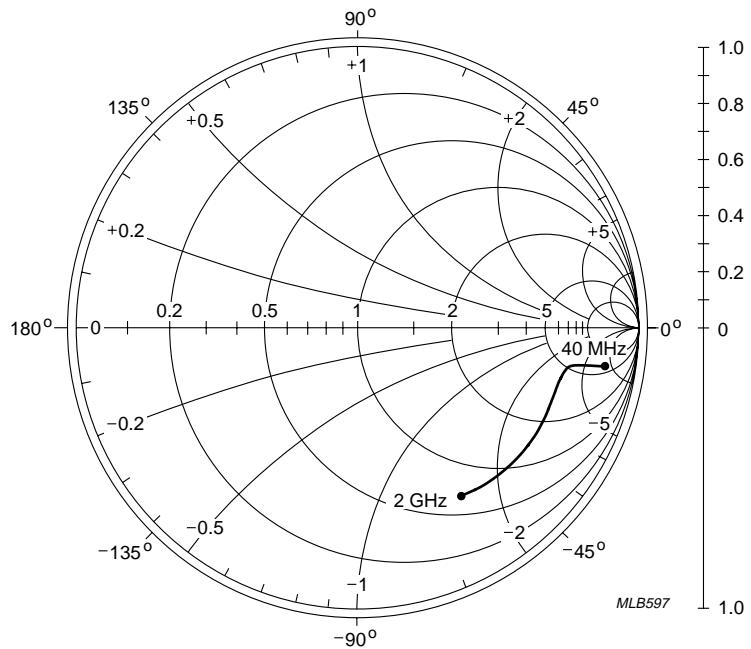
## NPN 1 GHz wideband transistor

BF547W

 $V_{CE} = 10 \text{ V}; I_C = 15 \text{ mA}; Z_0 = 50 \Omega.$ Fig.10 Common emitter input reflection coefficient ( $s_{11}$ ); typical values. $V_{CE} = 10 \text{ V}; I_C = 15 \text{ mA}.$ Fig.11 Common emitter forward transmission coefficient ( $s_{21}$ ); typical values.

## NPN 1 GHz wideband transistor

BF547W

 $V_{CE} = 10 \text{ V}; I_C = 15 \text{ mA}.$ Fig.12 Common emitter reverse transmission coefficient ( $s_{12}$ ); typical values. $V_{CE} = 10 \text{ V}; I_C = 15 \text{ mA}; Z_0 = 50 \Omega.$ Fig.13 Common emitter output reflection coefficient ( $s_{22}$ ); typical values.

## NPN 1 GHz wideband transistor

BF547W

## SPICE parameters for the BF547W crystal

SEQUENCE No.	PARAMETER	VALUE	UNIT
1	IS	289.1	aA
2	BF	94.29	–
3	NF	0.989	–
4	VAF	90.00	V
5	IKF	158.6	mA
6	ISE	426.6	aA
7	NE	1.491	–
8	BR	12.32	–
9	NR	0.989	–
10	VAR	19.39	V
11	IKR	24.75	mA
12	ISC	249.7	pA
13	NC	1.200	–
14	RB	50.00	Ω
15	IRB	1.000	μA
16	RBM	50.00	Ω
17	RE	0.500	Ω
18	RC	1.309	Ω
19 <sup>(1)</sup>	XTB	0.000	–
20 <sup>(1)</sup>	EG	1.110	eV
21 <sup>(1)</sup>	XTI	3.000	–
22	CJE	1.071	pF
23	VJE	727.3	mV
24	MJE	0.332	–
25	TF	92.98	ps
26	XTF	43.89	–
27	VTF	1.813	V
28	ITF	143.9	mA
29	PTF	0.000	deg
30	CJC	1.167	pF
31	VJC	489.0	mV
32	MJC	0.253	–
33	XCJC	0.150	–
34	TR	50.00	ns
35 <sup>(1)</sup>	CJS	0.000	F

SEQUENCE No.	PARAMETER	VALUE	UNIT
36 <sup>(1)</sup>	VJS	750.0	mV
37 <sup>(1)</sup>	MJS	0.000	–
38	FC	0.950	–

## Note

- These parameters have not been extracted, the default values are shown.

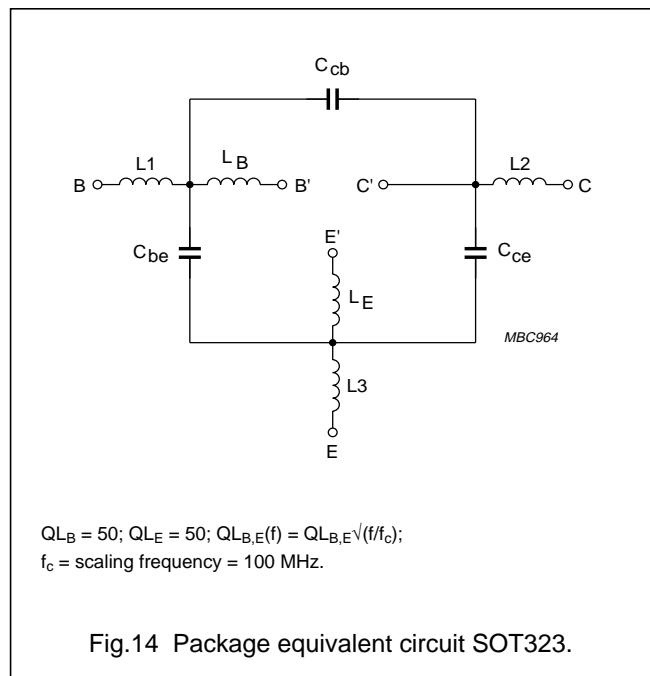


Fig.14 Package equivalent circuit SOT323.

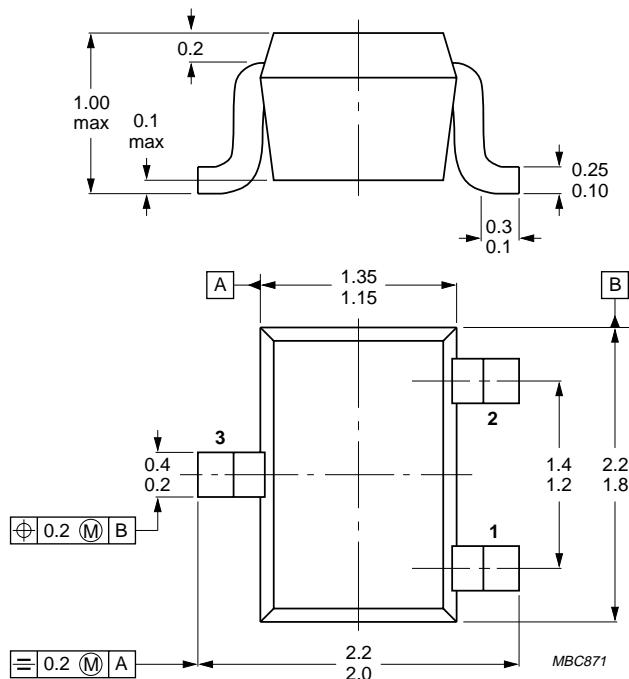
## List of components (see Fig.14).

DESIGNATION	VALUE	UNIT
C <sub>be</sub>	2	fF
C <sub>cb</sub>	100	fF
C <sub>ce</sub>	100	fF
L <sub>1</sub>	0.34	nH
L <sub>2</sub>	0.10	nH
L <sub>3</sub>	0.34	nH
L <sub>B</sub>	0.60	nH
L <sub>E</sub>	0.60	nH

## NPN 1 GHz wideband transistor

BF547W

## PACKAGE OUTLINE



Dimensions in mm.

Fig.15 SOT323.

## DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

## LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

NPN 1 GHz wideband transistor

BF547W

---

**NOTES**

NPN 1 GHz wideband transistor

BF547W

---

**NOTES**

## **Philips Semiconductors – a worldwide company**

**Argentina:** IEROD, Av. Juramento 1992 - 14.b, (1428)

BUENOS AIRES, Tel. (541)786 7633, Fax. (541)786 9367

**Australia:** 34 Waterloo Road, NORTH RYDE, NSW 2113,

Tel. (02)805 4455, Fax. (02)805 4466

**Austria:** Triester Str. 64, A-1101 WIEN, P.O. Box 213,

Tel. (01)60 101-1236, Fax. (01)60 101-1211

**Belgium:** Postbus 90050, 5600 PB EINDHOVEN, The Netherlands,

Tel. (31)40 783 749, Fax. (31)40 788 399

**Brazil:** Rua do Rocio 220 - 5<sup>th</sup> floor, Suite 51,

CEP: 04552-903-SÃO PAULO-SP, Brazil.

P.O. Box 7383 (01064-970).

Tel. (011)821-2327, Fax. (011)829-1849

**Canada:** INTEGRATED CIRCUITS:

Tel. (800)234-7381, Fax. (708)296-8556

DISCRETE SEMICONDUCTORS: 601 Milner Ave,

SCARBOROUGH, ONTARIO, M1B 1M8,

Tel. (0416)292 5161 ext. 2336, Fax. (0416)292 4477

**Chile:** Av. Santa Maria 0760, SANTIAGO,

Tel. (02)773 816, Fax. (02)777 6730

**Colombia:** IPRELENZO LTDA, Carrera 21 No. 56-17,

77621 BOGOTA, Tel. (571)249 7624/(571)217 4609,

Fax. (571)217 4549

**Denmark:** Prags Boulevard 80, PB 1919, DK-2300 COPENHAGEN S,

Tel. (032)88 2636, Fax. (031)57 1949

**Finland:** Siniakkiontie 3, FIN-02630 ESPOO,

Tel. (9)0-50261, Fax. (9)0-520971

**France:** 4 Rue du Port-aux-Vins, BP317,

92156 SURESNES Cedex,

Tel. (01)4099 6161, Fax. (01)4099 6427

**Germany:** PHILIPS COMPONENTS UB der Philips G.m.b.H.,

P.O. Box 10 63 23, 20043 HAMBURG,

Tel. (040)3296-0, Fax. (040)3296 213.

**Greece:** No. 15, 25th March Street, GR 17778 TAVROS,

Tel. (01)4894 339/4894 911, Fax. (01)4814 240

**Hong Kong:** PHILIPS HONG KONG Ltd., Components Div.,

6/F Philips Ind. Bldg., 24-28 Kung Yip St., KWAI CHUNG, N.T.,

Tel. (852)424 5121, Fax. (852)428 6729

**India:** Philips INDIA Ltd, Components Dept,

Shivsagar Estate, A Block ,

Dr. Annie Besant Rd. Worli, Bombay 400 018

Tel. (022)4938 541, Fax. (022)4938 722

**Indonesia:** Philips House, Jalan H.R. Rasuna Said Kav. 3-4,

P.O. Box 4252, JAKARTA 12950,

Tel. (021)5201 122, Fax. (021)5205 189

**Ireland:** Newstead, Clonskeagh, DUBLIN 14,

Tel. (01)640 000, Fax. (01)640 200

**Italy:** PHILIPS COMPONENTS S.r.l.,

Viale F. Testi, 327, 20162 MILANO,

Tel. (02)6752.3302, Fax. (02)6752 3300.

**Japan:** Philips Bldg 13-37, Kohnan 2-chome, Minato-ku, TOKYO 108,

Tel. (03)3740 5028, Fax. (03)3740 0580

**Korea:** (Republic of) Philips House, 260-199 Itaewon-dong,

Yongsan-ku, SEOUL, Tel. (02)794-5011, Fax. (02)798-8022

**Malaysia:** No. 76 Jalan Universiti, 46200 PETALING JAYA,

SELANGOR, Tel. (03)750 5214, Fax. (03)757 4880

**Mexico:** Philips Components, 5900 Gateway East, Suite 200,

EL PASO, TX 79905, Tel. 9-5(800)234-7381, Fax. (708)296-8556

**Netherlands:** Postbus 90050, 5600 PB EINDHOVEN, Bldg. VB

Tel. (040)783749, Fax. (040)788399

**New Zealand:** 2 Wagener Place, C.P.O. Box 1041, AUCKLAND,

Tel. (09)849-4160, Fax. (09)849-7811

**Norway:** Box 1, Manglerud 0612, OSLO,

Tel. (02)274 8000, Fax. (02)274 8341

**Pakistan:** Philips Electrical Industries of Pakistan Ltd.,

Exchange Bldg. ST-2/A, Block 9, KDA Scheme 5, Clifton,

KARACHI 75600, Tel. (021)587 4641-49,

Fax. (021)577035/5874546.

**Philippines:** PHILIPS SEMICONDUCTORS PHILIPPINES Inc,

106 Valero St. Salcedo Village, P.O. Box 2108 MCC, MAKATI,

Metro MANILA, Tel. (02)810 0161, Fax. (02)817 3474

**Portugal:** PHILIPS PORTUGUESA, S.A.,

Rua dr. António Loureiro Borges 5, Arquiparque - Miraflores,

Apartado 300, 2795 LINDA-A-VELHA,

Tel. (01)14163160/4163333, Fax. (01)14163174/4163366.

**Singapore:** Lorong 1, Toa Payoh, SINGAPORE 1231,

Tel. (65)350 2000, Fax. (65)251 6500

**South Africa:** S.A. PHILIPS Pty Ltd., Components Division,

195-215 Main Road Martindale, 2092 JOHANNESBURG,

P.O. Box 7430 Johannesburg 2000,

Tel. (011)470-5911, Fax. (011)470-5494.

**Spain:** Balmes 22, 08007 BARCELONA,

Tel. (03)301 6312, Fax. (03)301 42 43

**Sweden:** Kottbygatan 7, Akalla, S-164 85 STOCKHOLM,

Tel. (0)8-632 2000, Fax. (0)8-632 2745

**Switzerland:** Allmendstrasse 140, CH-8027 ZÜRICH,

Tel. (01)488 2211, Fax. (01)481 77 30

**Taiwan:** PHILIPS TAIWAN Ltd., 23-30F, 66, Chung Hsiao West

Road, Sec. 1. Taipeh, Taiwan ROC, P.O. Box 22978,

TAIPEI 100, Tel. (02)388 7666, Fax. (02)382 4382.

**Thailand:** PHILIPS ELECTRONICS (THAILAND) Ltd.,

209/2 Sanpavut-Bangna Road Prakanong,

Bangkok 10260, THAILAND,

Tel. (662)398-0141, Fax. (662)398-3319.

**Turkey:** Talatpasa Cad. No. 5, 80640 GÜLTEPE/ISTANBUL,

Tel. (0212)279 2770, Fax. (0212)269 3094

**United Kingdom:** Philips Semiconductors Limited, P.O. Box 65,

Philips House, Torrington Place, LONDON, WC1E 7HD,

Tel. (071)436 41 44, Fax. (071)323 03 42

**United States:** INTEGRATED CIRCUITS:

811 East Arques Avenue, SUNNYVALE, CA 94088-3409,

Tel. (800)234-7381, Fax. (708)296-8556

DISCRETE SEMICONDUCTORS: 2001 West Blue Heron Blvd.,

P.O. Box 10330, RIVIERA BEACH, FLORIDA 33404,

Tel. (800)447-3762 and (407)881-3200, Fax. (407)881-3300

**Uruguay:** Coronel Mora 433, MONTEVIDEO,

Tel. (02)70-4044, Fax. (02)92 0601

**For all other countries apply to:** Philips Semiconductors,

International Marketing and Sales, Building BAF-1,

P.O. Box 218, 5600 MD, EINDHOVEN, The Netherlands,

Telex 35000 phtcnl, Fax. +31-40-724825

SCD31

© Philips Electronics N.V. 1994

All rights are reserved. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner.

The information presented in this document does not form part of any quotation or contract, is believed to be accurate and reliable and may be changed without notice. No liability will be accepted by the publisher for any consequence of its use. Publication thereof does not convey nor imply any license under patent- or other industrial or intellectual property rights.

Printed in The Netherlands

123065/1500/02/pp12

Date of release: June 1994

Document order number:

9397 733 10011

## Philips Semiconductors



# PHILIPS